

EAST Search History

EAST Search History (Prior Art)

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	"20020004320" pn.	US-PGPUB; USPAT	OR	ON	2009/11/18 12:23
S1	2806027	circuit OR IC OR substrate OR wafer OR chip	US-PGPUB; USPAT	OR	ON	2009/02/04 15:28
S2	4708255	product\$4 OR manufactur \$3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:30
S3	2276	700/121.ccls.	US-PGPUB; USPAT	OR	ON	2009/02/04 15:30
S4	1189	700/97.ccls.	US-PGPUB; USPAT	OR	ON	2009/02/04 15:31
S5	50	700/124.ccls.	US-PGPUB; USPAT	OR	ON	2009/02/04 15:31
S6	78	700/125.ccls.	US-PGPUB; USPAT	OR	ON	2009/02/04 15:31
S7	8	S3 AND S6	US-PGPUB; USPAT	OR	ON	2009/02/04 15:31
S8	609093	(product OR device OR unit) WITH (identification OR identif\$4 OR mark\$3)	US-PGPUB; USPAT	OR	ON	2009/02/04 15:32
S9	912999	S1 WITH S2	US-PGPUB; USPAT	OR	ON	2009/02/04 15:38
S10	370284	S1 WITH mount\$3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:38
S11	38287	S10 WITH S2	US-PGPUB; USPAT	OR	ON	2009/02/04 15:39
S12	555	S11 SAME S8	US-PGPUB; USPAT	OR	ON	2009/02/04 15:51
S13	668401	(product OR device OR unit OR workpiece) WITH (identification OR identif\$4 OR mark\$3 OR ID OR tag)	US-PGPUB; USPAT	OR	ON	2009/02/04 15:52
S14	702	S11 SAME S13	US-PGPUB; USPAT	OR	ON	2009/02/04 15:52
S15	524	S11 WITH S13	US-PGPUB; USPAT	OR	ON	2009/02/04 15:53
S16	6907	S14 SANE S3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:53
S17	0	S14 SAME S3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:53

S18	7	S14 AND S3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:53
S19	0	S14 AND S4	US-PGPUB; USPAT	OR	ON	2009/02/04 15:54
S20	0	S14 AND S5	US-PGPUB; USPAT	OR	ON	2009/02/04 15:54
S21	0	S14 AND S6	US-PGPUB; USPAT	OR	ON	2009/02/04 15:54
S22	764012	(product OR device OR unit OR workpiece) WITH mount\$3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:55
S23	19380	(electronic ADJ2 device) WITH mount\$3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:58
S24	34863	multi ADJ2 S1	US-PGPUB; USPAT	OR	ON	2009/02/04 15:59
S25	4265	S24 WITH mount\$3	US-PGPUB; USPAT	OR	ON	2009/02/04 15:59
S26	36	S25 SAME S13	US-PGPUB; USPAT	OR	ON	2009/02/04 16:00
S27	18232	MCP OR ((multi ADJ2 chip) ADJ2 package)	US-PGPUB; USPAT	OR	ON	2009/02/04 16:29
S28	1129	S27 WITH mount\$3	US-PGPUB; USPAT	OR	ON	2009/02/04 16:31
S29	11	S28 WITH (identification OR identif\$4 OR mark\$3 OR ID OR tag)	US-PGPUB; USPAT	OR	ON	2009/02/04 16:32
S30	2806027	circuit OR IC OR substrate OR wafer OR chip	US-PGPUB; USPAT	OR	ON	2009/02/04 17:37
S31	18232	MCP OR ((multi ADJ2 chip) ADJ2 package)	US-PGPUB; USPAT	OR	ON	2009/02/04 17:37
S32	933	((manufacturing WITH design\$3) WITH data) WITH (S30 OR S31)	US-PGPUB; USPAT	OR	ON	2009/02/04 17:37
S33	379	700/115.ccls.	US-PGPUB; USPAT	OR	ON	2009/02/04 17:37
S34	2276	700/121.ccls.	US-PGPUB; USPAT	OR	ON	2009/02/04 17:38
S35	72	S33 AND S34	US-PGPUB; USPAT	OR	ON	2009/02/04 17:38
S36	0	S33 AND S32	US-PGPUB; USPAT	OR	ON	2009/02/04 17:42
S37	797	print\$3 WITH (post\$2 ADJ2 stamp\$1)	US-PGPUB; USPAT	OR	ON	2009/02/05 15:04
S38	244	print\$3 WITH correlat\$3 WITH (cut OR perforat\$3 OR separat\$3)	US-PGPUB; USPAT	OR	ON	2009/02/05 15:06

S39	0	S37 SAME S38	US-PGPUB; USPAT	OR	ON	2009/02/05 15:06
S40	0	S37 AND S38	US-PGPUB; USPAT	OR	ON	2009/02/05 15:06
S41	0	S38 WITH (post\$2 ADJ2 stamp\$1)	US-PGPUB; USPAT	OR	ON	2009/02/05 15:06
S42	0	S38 SAME (post\$2 ADJ2 stamp\$1)	US-PGPUB; USPAT	OR	ON	2009/02/05 15:06
S43	0	S38 AND (post\$2 ADJ2 stamp\$1)	US-PGPUB; USPAT	OR	ON	2009/02/05 15:06
S44	46	S37.ab.	US-PGPUB; USPAT	OR	ON	2009/02/05 15:14
S45	5	S37 WITH ((identification OR identifying OR id) ADJ2 (data OR information OR code\$1))	US-PGPUB; USPAT	OR	ON	2009/02/05 15:15
S46	32	("1590158" "4725077" "4872706" "5044669" "5064222" "5098130" "5267754").PN. OR ("5423573").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2009/02/05 15:16
S47	334	(post\$3 ADJ stamp) WITH (ID OR identification OR code)	US-PGPUB; USPAT	OR	ON	2009/02/10 09:44
S48	161	(post\$3 ADJ stamp) WITH (perforat\$3 OR separat\$3)	US-PGPUB; USPAT	OR	ON	2009/02/10 09:45
S49	14	S47 SAME S48	US-PGPUB; USPAT	OR	ON	2009/02/10 09:46
S50	2811124	circuit OR IC OR substrate OR wafer OR chip	US-PGPUB; USPAT	OR	ON	2009/02/10 10:19
S51	371006	mount\$3 WITH S50	US-PGPUB; USPAT	OR	ON	2009/02/10 10:19
S52	873	S51 WITH ((production OR manufactur\$3) WITH (data OR database OR information))	US-PGPUB; USPAT	OR	ON	2009/02/10 10:20
S53	215702	S50 WITH (identification OR identif\$4 OR mark\$3)	US-PGPUB; USPAT	OR	ON	2009/02/10 10:20
S54	139	S52 SAME S53	US-PGPUB; USPAT	OR	ON	2009/02/10 10:21
S55	30	(S51 WITH ((production OR manufactur\$3) WITH (data OR database OR information))) ab.	US-PGPUB; USPAT	OR	ON	2009/02/10 10:46
S56	1	(S51 WITH ((production OR manufactur\$3) WITH (database OR (data ADJ processing)))) ab.	US-PGPUB; USPAT	OR	ON	2009/02/10 10:47

S57	40	S51 WITH ((production OR manufactur\$3) WITH (database OR (data ADJ processing)))	US-PGPUB; USPAT	OR	ON	2009/02/10 10:48
S58	489	database WITH ((production OR manufactur\$3 OR processing) NEAR3 histor\$3)	US-PGPUB; USPAT	OR	ON	2009/02/10 11:22
S59	489	(database WITH ((production OR manufactur\$3 OR processing) NEAR3 histor\$3))	US-PGPUB; USPAT	OR	ON	2009/02/10 11:23
S60	17	(database WITH ((production OR manufactur\$3 OR processing) NEAR3 histor\$3)).ab.	US-PGPUB; USPAT	OR	ON	2009/02/10 11:23
S61	154184	substrate WITH ((multi ADJ piece) OR multiple OR sheet)	US-PGPUB; USPAT	OR	ON	2009/08/04 11:19
S62	336	substrate WITH ((multi ADJ piece) OR (multiple ADJ sheet))	US-PGPUB; USPAT	OR	ON	2009/08/04 11:20
S63	23	separat\$3 WITH S62	US-PGPUB; USPAT	OR	ON	2009/08/04 11:20
S64	93801	substrate WITH sheet	US-PGPUB; USPAT	OR	ON	2009/08/04 12:49
S65	1117	level WITH S64	US-PGPUB; USPAT	OR	ON	2009/08/04 12:49
S66	5679	separat\$3 WITH S64	US-PGPUB; USPAT	OR	ON	2009/08/04 13:03
S67	2940918	circuit OR IC OR substrate OR wafer OR chip	US-PGPUB; USPAT	OR	ON	2009/08/04 13:08
S68	93801	S64 SAME S67	US-PGPUB; USPAT	OR	ON	2009/08/04 13:08
S69	336	substrate WITH ((multi ADJ piece) OR (multiple ADJ sheet))	US-PGPUB; USPAT	OR	ON	2009/08/04 13:09
S70	212	S64 WITH S69	US-PGPUB; USPAT	OR	ON	2009/08/04 13:09
S71	446229	circuit WITH (substrate OR wafer OR chip)	US-PGPUB; USPAT	OR	ON	2009/08/04 13:25
S72	7717	S71 WITH sheet	US-PGPUB; USPAT	OR	ON	2009/08/04 13:25
S73	798	S72 WITH produc\$4	US-PGPUB; USPAT	OR	ON	2009/08/04 13:25

S74	1	S73 WITH S69	US-PGPUB; USPAT	OR	ON	2009/08/04 13:26
S75	297849	(product OR device OR unit OR workpiece) WITH ((manufactur\$3 OR produc\$3 OR mak\$3 OR assembl\$3) WITH (identification OR identif\$4 OR mark\$3 OR ID OR tag))	US-PGPUB; USPAT	OR	ON	2009/08/04 14:16
S76	18957	S67 WITH S75	US-PGPUB; USPAT	OR	ON	2009/08/04 14:17
S77	343271	(substrate OR circuit OR IC) WITH mount\$3	US-PGPUB; USPAT	OR	ON	2009/08/04 14:20
S78	773	S76 SAME S77	US-PGPUB; USPAT	OR	ON	2009/08/04 14:20
S79	578	S76 WITH S77	US-PGPUB; USPAT	OR	ON	2009/08/04 14:21
S80	4122	S64 WITH S77	US-PGPUB; USPAT	OR	ON	2009/08/04 14:21
S81	9	S76 WITH S80	US-PGPUB; USPAT	OR	ON	2009/08/04 14:21
S82	5667	S68 SAME S77	US-PGPUB; USPAT	OR	ON	2009/08/04 14:23
S83	12	S76 SAME S82	US-PGPUB; USPAT	OR	ON	2009/08/04 14:23
S84	16779	((information OR identification OR data) WITH (saving OR storing OR storage OR record\$3)) WITH S75	US-PGPUB; USPAT	OR	ON	2009/08/04 14:31
S85	1356	((information OR identification OR data) WITH (saving OR storing OR storage OR record\$3)) WITH S76	US-PGPUB; USPAT	OR	ON	2009/08/04 14:31
S86	41	((information OR identification OR data) WITH (saving OR storing OR storage OR record\$3)) SAME S82	US-PGPUB; USPAT	OR	ON	2009/08/04 14:32
S87	248615	((information OR identification OR data) WITH (saving OR storing OR storage OR record\$3)) SAME (manufactur\$3 OR produc\$3)	US-PGPUB; USPAT	OR	ON	2009/08/05 14:45
S88	1099298	(circuit OR IC OR substrate OR wafer OR chip) WITH (manufactur\$3 OR produc\$3 OR mak\$3)	US-PGPUB; USPAT	OR	ON	2009/08/05 14:46

S89	197295	((information OR identification OR data) WITH (saving OR storing OR storage OR record\$3)) WITH (manufactur\$3 OR produc\$3 OR mak\$3)	US-PGPUB; USPAT	OR	ON	2009/08/05 14:46
S90	20545	S89 WITH S88	US-PGPUB; USPAT	OR	ON	2009/08/05 14:47
S91	1019	progress\$4 WITH S89	US-PGPUB; USPAT	OR	ON	2009/08/05 14:47
S92	71	S91 WITH S88	US-PGPUB; USPAT	OR	ON	2009/08/05 14:47
S93	958	substrate WITH identification WITH information	US-PGPUB; USPAT	OR	ON	2009/08/05 15:22
S94	240	S93 WITH (manufactur\$3 OR produc\$3 OR mak\$3)	US-PGPUB; USPAT	OR	ON	2009/08/05 15:22
S95	193	@AD< "20060530" AND S94	US-PGPUB; USPAT	OR	ON	2009/08/05 15:23
S96	1	"6555400".pn. AND (electronic ADJ file)	US-PGPUB; USPAT	OR	ON	2009/08/05 16:42
S97	18814	(chip OR substrate OR wafer OR dice OR die) ADJ3 (ID OR identification OR code OR barcode)	US-PGPUB; USPAT	OR	ON	2009/11/17 14:00
S98	20777	(sheet OR page OR strip) ADJ3 (ID OR identification OR code OR barcode)	US-PGPUB; USPAT	OR	ON	2009/11/17 14:01
S99	134	S97 SAME S98	US-PGPUB; USPAT	OR	ON	2009/11/17 14:01
S100	1	"20070089113".pn.	US-PGPUB; USPAT	OR	ON	2009/11/17 14:14
S101	58	("20020004320" "3407925" "3982159" "4293175" "4330163" "4417777" "4765471" "4804130" "4899107" "4906194" "5045975" "5055777" "5106309" "5131535" "5176525" "5195237" "5278447" "5359285" "5366380" "5455390" "5476211" "5495667" "5500605" "5528825" "5541525" "5561594" "5565008" "5599194" "5635832" "5644249" "5646816" "5648893" "5653599" "5686842" "5742487" "5772451" "5783461"	US-PGPUB; USPAT; USOCR	OR	ON	2009/11/17 14:21

		"5807104" "5829128" "5848702" "5863814" "5932891" "5949242" "5998864" "6031282" "6033935" "6064218" "6078500" "6078845" "6087845" "6147316" "6181567" "6184699" "6219908" "6264533" "6275052" "6292003"). PN.				
S102	0	S99 AND S101	US-PGPUB; USPAT	OR	ON	2009/11/17 14:22
S103	243	(ID OR identification OR code OR barcode) ADJ6 ((chip OR substrate OR wafer OR die OR dice) ADJ3 (sheet OR page OR strip))	US-PGPUB; USPAT	OR	ON	2009/11/17 14:24
S104	129	@AD< "20031128" AND S103	US-PGPUB; USPAT	OR	ON	2009/11/17 14:25

EAST Search History (Interference)

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